IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved international and Pan-American copyright conventions.			The level of the l	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
Supplier	Information													
Company name* Company to				unique ID			Unique ID Authority				Response Date*			
nsemi											2024-04-25			
Contact N	ame		Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-I	Env-Stewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
uthorize	d Representative*	Title - Representative			P	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Ite		n Number Mfr Item Name			1	Effective Date	e Date Version Manufacturing Site		Manufacturing Site	V	Veight*	UOM	Unit Type
		SZNUF6401MNWT1 XDFN12W12 EMI		I FILTER WITH	ESD 2	2024-04-25	5 MY1		9	.81	mg	Each		
Manufa	cturing Proccess Informa	ation												
	Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-	J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Pea					Temperatu	re Nun	nber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy 1					260		C	30	second	ls 3				
Comments														
evel 1 - m	aximum time at peak tempera	ture during sol	dering is 10-3	0 seconds										
or more	information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg
Die Attach	0.03	mg		Epoxy resin	proprietary data		0.006	mg
			Supplier	Silver (Ag)	7440-22-4		0.024	mg
Lead Frame	2.27	mg	Supplier	Silver (Ag)	7440-22-4		0.0454	mg
			Supplier	Tin (Sn)	7440-31-5		0.0057	mg
			Supplier	Zinc (Zn)	7440-66-6		0.005	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0057	mg
			Supplier	Copper (Cu)	7440-50-8		2.2083	mg
Mold Compound-Black	6.81	mg		Epoxy resin	proprietary data		0.3405	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1566	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.3405	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0272	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1566	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.7885	mg
Plating	0.44	mg	Supplier	Tin (Sn)	7440-31-5		0.44	mg
Wire Bond - Au	0.13	mg	Supplier	Gold (Au)	7440-57-5		0.13	mg